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RECORDATION

03-08-2000

DEPARTMENT OF COMMERCE
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RECEIVED PATENT



101284028

Documents or copy thereof.

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To the Honorable Commissioner of Patents and Trademark

1. Name of conveying party(ies):

Katsuya Baba
Kenji Ota

OPR/FINANCE

2. Name and address of receiving party(ies):

Name: Dow Corning Toray Silicone Company, Ltd.Internal Address: 4th Floor, AIG Building

Additional names(s) of conveying party(ies)

☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ OtherExecution Date: December 22, 1999Street Address: 1-1-3, Marunouchi, Chiyoda-kuTokyo 100-0005, Japan

City: _____ State: _____ ZIP: _____

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application number(s) or registration numbers(s):

If this document is being filed together with a new application, the execution date of the application is: December 22, 1999

A. Patent Application No.(s)

09/451,741

Filed
11/30/99

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Dow Corning CorporationInternal Address: Attn: William F. BoleyPatent Department - Mail CO1232Street Address: 2200 W. Salzburg RoadCity: Midland State: MI ZIP: 48686

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 3.41):.....\$ 40.00☐ Enclosed☒ Authorized to be charged to deposit account

8. Deposit account number:

04-1520

03/07/2000 DNGUEN 00000266 041520 09451741

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

William F. Boley

Name of Person Signing

Signature

Date

Total number of pages including cover sheet, attachments, and document:

3

PATENT

REEL: 010587 FRAME: 0823

ASSIGNMENT

WHEREAS We, KATSUYA BABA, and KENJI OTA have invented certain new and useful improvements in

SILICONE RUBBER BASE COMPOUND FOR ELECTRICAL WIRE COATING, SILICONE COMPOSITION FOR ELECTRICAL WIRE COATING, AND PROCESS FOR THE PRODUCTION OF SILICONE RUBBER COATED ELECTRICAL WIRE

for which application for United States Letters Patent has been executed by us on this 22nd day of December, 1999; and,

WHEREAS, DOW CORNING TORAY SILICONE COMPANY, LTD., 4th Floor, AIG Building, 1-1-3, Marunouchi, Chiyoda-ku, Tokyo 100-0005, JAPAN, is desirous of acquiring the said invention and said application and any and all Letters Patent that may be obtained therefor or thereupon, and all reissues and extensions thereof;

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that for and in consideration of the sum of 250 Yen, and other good and valuable considerations, to us in hand paid by the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, the receipt of which is hereby acknowledged, we have sold, assigned, transferred and set over and by these presents do sell, assign, transfer and set over unto the said DOW CORNING TORAY SILICONE COMPANY, LTD., its successors, and assigns, the full and exclusive right, title and interest in and to said invention and said application for Letters Patent of the United States therefor, and in and to any Divisions and Continuations thereof and in and to any and all United States Letters Patent and reissues and extensions thereof that may be issued for the said invention, to have and to hold for its own use and behoof and the use and behoof of its successors and assigns as fully and entirely as the same might be enjoyed by us if this sale and assignment had not been made; and

HEREBY AUTHORIZE and request the Commissioner of Patents and Trademarks to issue the said Letters Patent and any reissues and extensions thereof to the said DOW CORNING TORAY SILICONE COMPANY, LTD. as assigns of the entire right, title and interest in and to the said invention and said application and Letters Patent issued therefor or thereupon; and

HEREBY AGREE to execute all instruments and documents within our power which may be necessary for the carrying out of this assignment in full; and to execute any divisional or continuing application or applications which may be necessary or proper to obtain full protection on the invention hereby assigned; and to

execute and all supplemental oaths and preliminary statements should the same be proper and necessary in the prosecution of the aforesaid applications; and

HEREBY FURTHER ASSIGN unto the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors, and assigns, the whole right, title and interest in and to the invention disclosed in the said application throughout all countries foreign to the United States, and do hereby ratify any acts of the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns, in applying for patents therefor in its own name in countries where such procedure is proper and do agree to execute applications for said invention in the several countries where it is necessary that the same be executed by the inventors, and to execute assignments of such applications and the patents to be obtained therefor to the said DOW CORNING TORAY SILICONE COMPANY, LIMITED, its successors and assigns.

IN WITNESS WHEREOF I have hereunto set my hand

Katsuya Baba

KATSUYA BABA

Dated: Dec. 22, 1999

This is to certify that KATSUYA BABA has signed this document in my presence this 22nd day of December, 1999, Japan.

Katsuyoshi Nakasuji

Signature of Witness

KATSUYOSHI NAKASUJI

IN WITNESS WHEREOF I have hereunto set my hand

Kenji Ota

KENJI OTA

Dated: Dec. 22, 1999

This is to certify that KENJI OTA has signed this document in my presence this 22nd day of December, 1999, Japan.

Katsuyoshi Nakasuji

Signature of Witness

KATSUYOSHI NAKASUJI